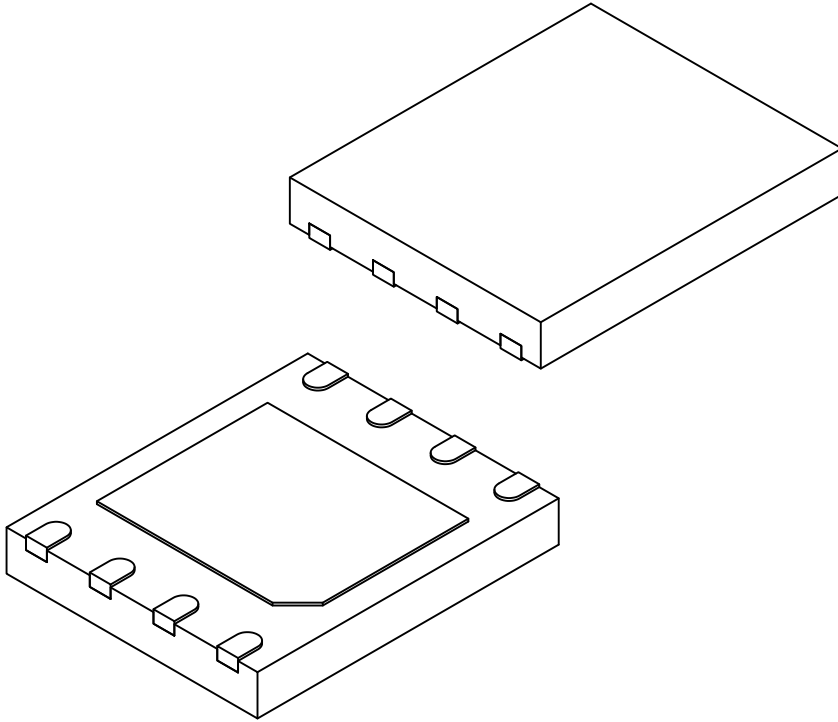


8-Lead Plastic Very, Very Thin Small Outline No-Lead (MF) - 6x5x0.8 mm Body [WSON] (Also Called WDFN)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Terminals	N		8		
Pitch	e		1.27 BSC		
Overall Height	A	0.70	0.75	0.80	
Standoff	A1	0.00	0.02	0.05	
Terminal Thickness	A3	0.20 REF			
Overall Width	D	6.00 BSC			
Exposed Pad Width	D2	3.40 BSC			
Overall Length	E	5.00 BSC			
Exposed Pad Length	E2	4.00 BSC			
Terminal Width	b	0.35	0.42	0.48	
Terminal Length	L	0.50	0.60	0.70	
Terminal-to-Exposed-Pad	K	0.20	-	-	

Notes:

1. The Pin 1 visual index feature may vary, but it must be located within the hatched area.
2. The package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M
 BSC: Basic Dimension. The theoretically exact value is shown without tolerances.
 REF: Reference Dimension, usually without tolerances, is for information purposes only.